

Ceramic

Bandpass Filter & Balun BBFCG2-532+

50Ω 5000 to 5700 MHz

The Big Deal

- Tiny size, (0805)
- Compact design includes Balun & Filter in one package
- Low cost



CASE STYLE: GE0805C-2

Product Overview

Mini-Circuits' BBFCG2-532+ is a tiny ceramic RF balun filter with an impedance ratio of 1:2, covering a variety of wireless communications applications from 5000 to 5700 MHz. This model provides low insertion loss, low phase unbalance (relative to 180°), low amplitude unbalance, and RF input power handling up to 2W. It provides DC isolation from input to output allowing it to be used for DC biasing of external circuits at the output. Fabricated using LTCC technology, the unit comes housed in a tiny, rugged ceramic package (0.079" x 0.049" x 0.037") suitable for harsh operating environments.

Key Features

Feature	Advantages
Compact Design	Integrates filter and balun in one tiny package
2W power handling	Supports a wide range of power requirements
DC Isolated from input to output	Can be used to DC bias external circuits at the output.
Tiny size, 0805	Accommodates tight space requirements for dense PCB layouts.
LTCC construction	LTCC process enables tiny size and low cost, suitable for high-volume production. Rugged ceramic package provides excellent reliability in harsh operating environments.

Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Ceramic Bandpass Filter & Balun

50Ω 5000 to 5700 MHz

BBFCG2-532+



Generic photo used for illustration purposes only

CASE STYLE: GE0805C-2

Features

- Small size (0.079"x0.049"x0.037")
- Temperature stable
- Hermetically sealed

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Applications

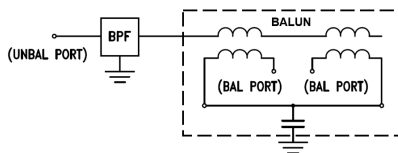
- ISM Band
- WiFi / WLAN

Electrical Specifications at 25°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			2			
Pass Band	Insertion Loss ¹	F1-F2	5000 - 5700	—	—	3 dB
	Return Loss	F1-F2	5000 - 5700	9.5	—	— dB
Stop Band, Lower	Rejection	DC - F3	10 - 3000	30	—	— dB
Stop Band, Upper	Rejection	F4-F5	8200 - 11000	20	—	— dB
Amplitude Unbalance	F1-F2	5000 - 5700	—	2	—	— dB
Phase Unbalance	F1-F2	5000 - 5700	—	5	15	degree

1. Tested on Evaluation Board TB-BBFCG2-532+

Functional Schematic



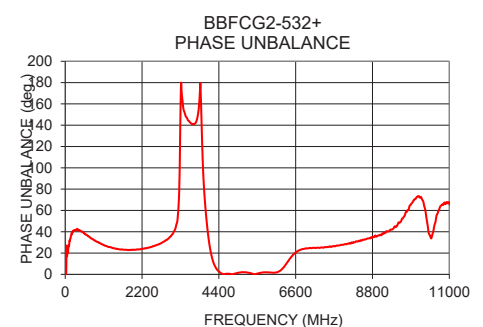
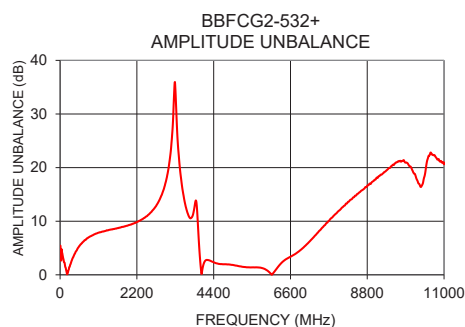
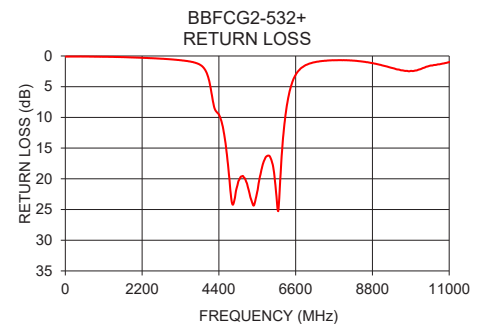
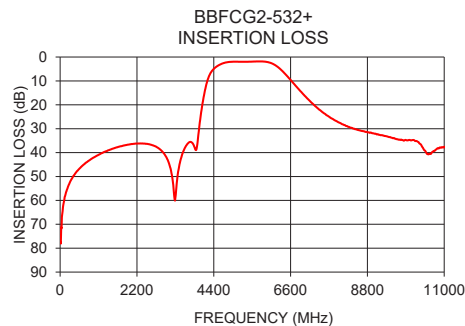
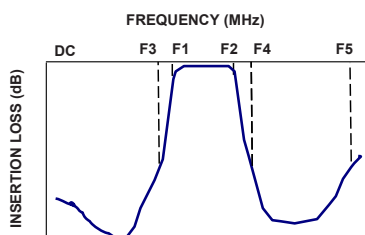
Maximum Ratings

Operating Temperature	-55°C to 125°C
Storage Temperature ²	-55°C to 125°C
RF Power Input ³	2W at 25°C

2. Refer to product storage temperature after installation
Suggestion for T&R unused product storage condition:
+5 ~ +35 °C, Humidity 45~75%RH, 12 month Max

3. Derate linearly to 0.5W at 125°C.
Permanent damage may occur if any of these limits exceeded.

Typical Frequency Response



Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuit's standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/WCLStore/terms.jsp



Typical Performance Data

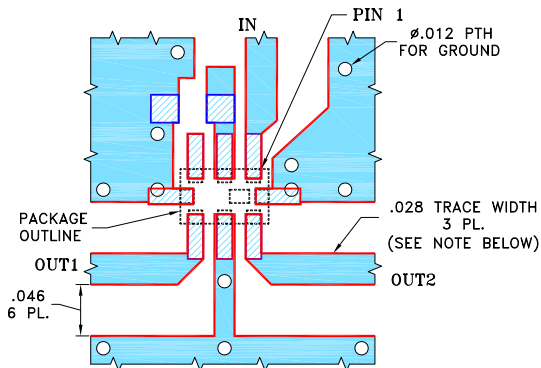
Frequency (GHz)	Insertion Loss (dB)	Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (Deg.)
10	77.38	0.10	5.44	21.45
1000	41.74	0.13	7.61	29.18
2000	36.54	0.25	9.33	23.13
3000	40.89	0.54	16.63	35.07
4000	27.45	2.21	3.74	68.86
5000	1.96	19.95	1.77	1.75
5700	1.84	17.01	1.36	1.94
6000	2.33	19.91	0.45	1.66
7000	16.14	1.23	5.28	24.74
8200	28.89	0.73	13.30	29.95
9000	32.07	1.41	17.66	36.74
11000	37.53	1.00	20.63	66.73

Pad Connections

UNBALANCED PORT	1
BALANCED PORT	5,7
GROUND	4,6,8
NC	3
NC or DC Feed	2

Product Marking: N/A

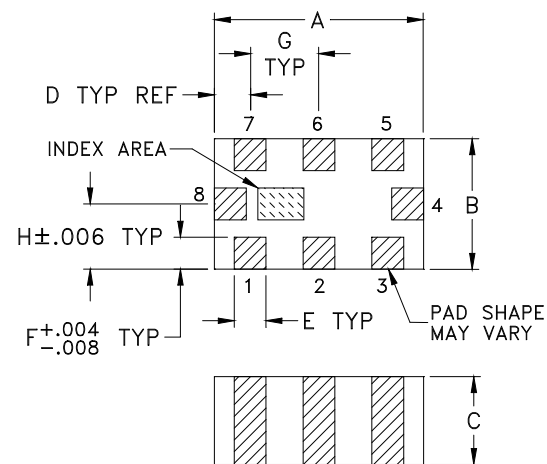
Evaluation Board MCL P/N: TB-BBFCG2-532+
Suggested PCB Layout (PL-551)



NOTES:

- TRACE WIDTH IS SHOWN FOR FR4, GRADE IT-180TC (ITEQ CORP.) WITH DIELECTRIC THICKNESS .018±.0015. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
 - BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Outline Drawing



Outline Dimensions (inch / mm)

A	B	C	D	E
.079	.049	.037	.014	.012
2.01	1.24	0.94	0.36	0.30
F	G	H		wt
.012	.026	.025		grams
0.30	0.66	0.64		.008

Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Ceramic Balance Filter

BBFCG2-532+

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
10	77.38	0.10	5.44	21.45
50	67.01	0.10	4.20	16.91
100	61.21	0.10	2.80	26.27
200	55.34	0.09	0.10	38.56
300	51.76	0.09	2.00	41.67
400	49.39	0.09	3.66	41.38
500	47.56	0.09	4.88	40.16
600	45.98	0.09	5.73	37.02
700	44.77	0.10	6.45	35.02
800	43.58	0.11	6.90	32.87
900	42.58	0.11	7.28	30.74
1000	41.74	0.13	7.61	29.18
1500	38.38	0.16	8.49	23.92
2000	36.54	0.25	9.33	23.13
2500	36.35	0.37	11.02	26.27
3000	40.89	0.54	16.63	35.07
3200	49.36	0.64	25.25	48.47
3400	46.47	0.76	22.26	153.28
3600	37.31	0.93	12.70	141.81
3800	36.21	1.26	11.09	149.75
4000	27.45	2.21	3.74	68.86
4200	10.82	6.39	2.78	16.24
4400	4.97	9.53	2.35	2.71
4600	3.00	14.61	2.00	0.52
4800	2.15	24.23	1.94	0.10
5000	1.96	19.95	1.77	1.75
5050	1.96	19.62	1.72	1.94
5100	1.97	19.61	1.64	2.03
5150	1.99	19.98	1.58	1.97
5200	1.99	20.69	1.53	1.88
5250	2.00	21.75	1.48	1.53
5300	1.99	22.93	1.45	1.19
5350	1.99	23.78	1.40	0.70
5400	1.97	24.36	1.40	0.32
5450	1.95	23.40	1.38	0.26
5500	1.92	22.11	1.39	0.68
5550	1.89	20.41	1.39	1.15
5600	1.87	19.08	1.39	1.51
5650	1.85	17.85	1.39	1.76
5700	1.84	17.01	1.36	1.94
5800	1.86	16.24	1.24	1.94
5900	2.01	16.86	0.94	1.70
6000	2.33	19.91	0.45	1.66
6100	2.91	25.28	0.27	2.41
6200	3.79	16.28	1.11	4.67
6300	4.97	10.06	1.93	8.49
6400	6.38	6.47	2.57	13.13
6500	7.94	4.35	3.02	17.37
6600	9.58	3.07	3.38	20.53
6700	11.25	2.31	3.75	22.54
6800	12.93	1.81	4.19	23.73
6900	14.55	1.46	4.69	24.44
7000	16.14	1.23	5.28	24.74
7100	17.63	1.07	5.89	24.91
7200	19.10	0.95	6.58	24.96
7300	20.47	0.85	7.29	24.98
7400	21.74	0.80	8.00	25.05
7500	22.91	0.75	8.72	25.62
7600	23.94	0.72	9.37	25.80
7700	24.96	0.70	10.07	26.61
7800	25.86	0.69	10.73	27.09
7900	26.73	0.68	11.39	27.80
8000	27.48	0.69	12.01	28.32
8400	29.98	0.83	14.45	31.43
8800	31.49	1.16	16.62	34.48
9200	32.69	1.69	18.67	40.51
9600	34.19	2.30	20.80	49.36
10000	34.71	2.41	20.36	70.50
10400	38.24	1.68	17.26	40.96
10800	38.27	1.25	21.58	65.65
11200	38.23	0.79	20.60	66.33
11600	40.98	0.54	21.52	70.25
12000	42.79	0.40	21.45	90.29



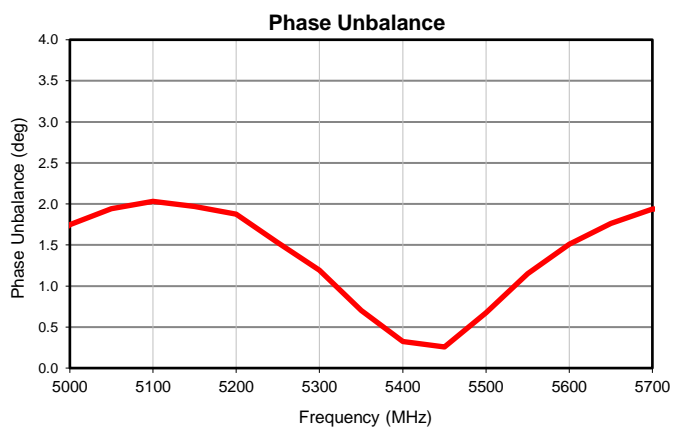
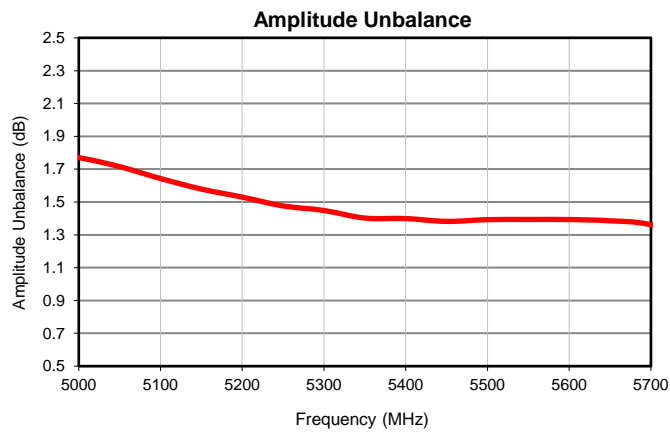
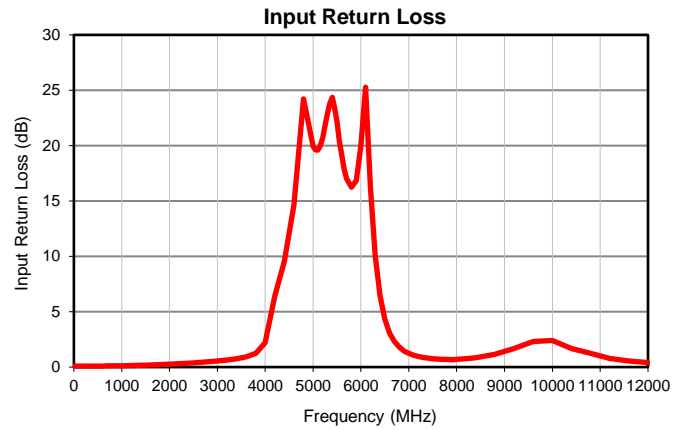
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 • Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



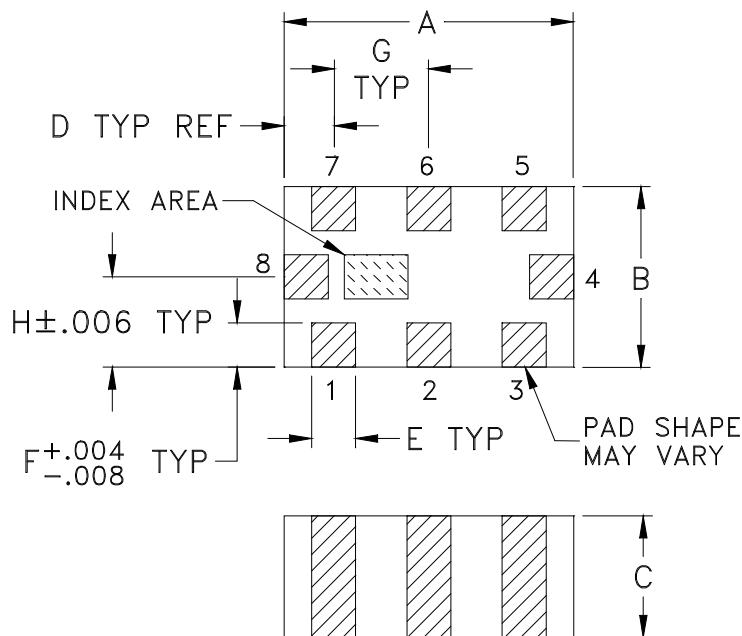
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

IF/RF MICROWAVE COMPONENTS

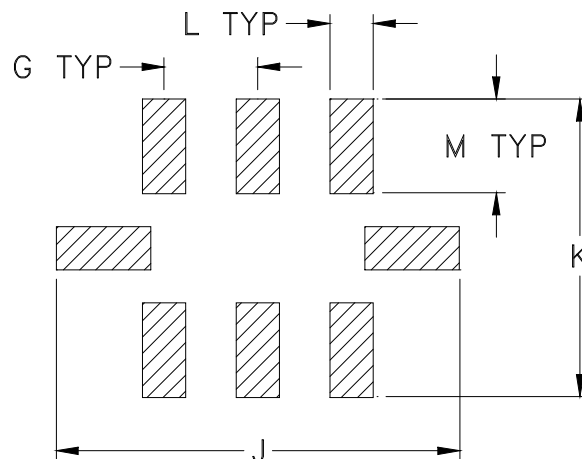
Typical Performance Data



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L
GE0805C-2	.079 (2.00)	.049 (1.25)	.037 (0.95)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.025 (0.63)	.134 (3.40)	.110 (2.80)	.014 (0.35)

CASE #	M	WT. GRAM
GE0805C-2	.039 (1.00)	.008

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate over Nickel plate. All models, no (+) suffix.
- Pad tolerance to be non-cumulative. Minimum spacing between each pad is .004 (0.1).



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R



ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	



ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



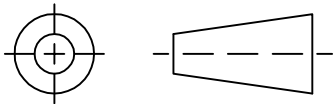
INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

Mini-Circuits ISO 9001 & ISO 14001 Certified

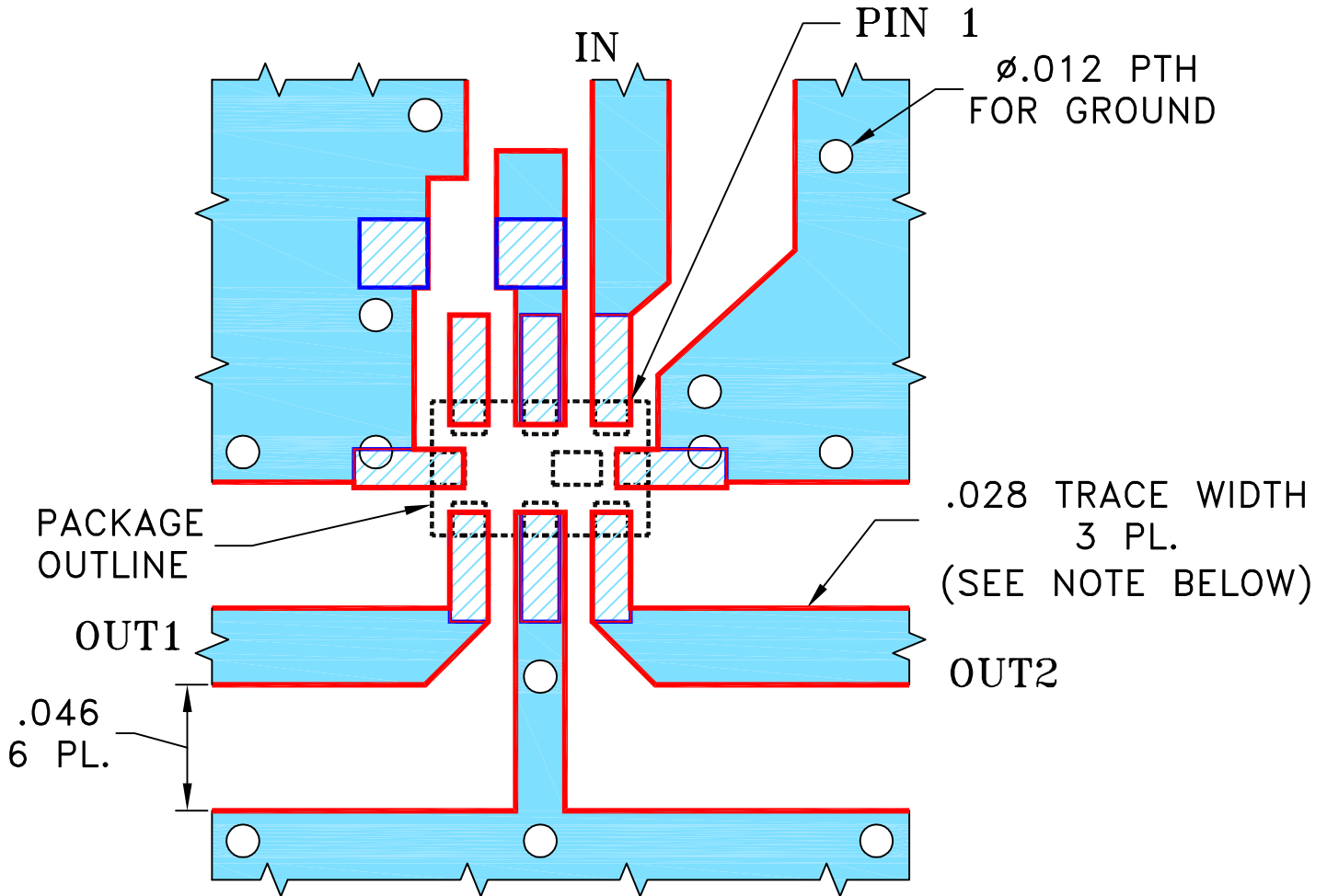
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M168200	NEW RELEASE	05/31/18	NP	SL

SUGGESTED MOUNTING CONFIGURATION
FOR GE0805C-2 CASE STYLE, "08TJ01" PIN CODE



NOTES:

- TRACE WIDTH IS SHOWN FOR FR4, GRADE IT-180TC (ITEQ CORP.) WITH DIELECTRIC THICKNESS $.016 \pm .0015$. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN NP	05/30/18
TOLERANCES ON:	CHECKED GF	05/30/18
2 PL DECIMALS ±	APPROVED SL	05/31/18
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		

Mini-Circuits® 13 Neptune Avenue
Brooklyn NY 11235

PL, 08TJ01, GE0805C-2, TB-1034+

SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-551	REV: OR
-----------	---------------------	--------------------------	------------

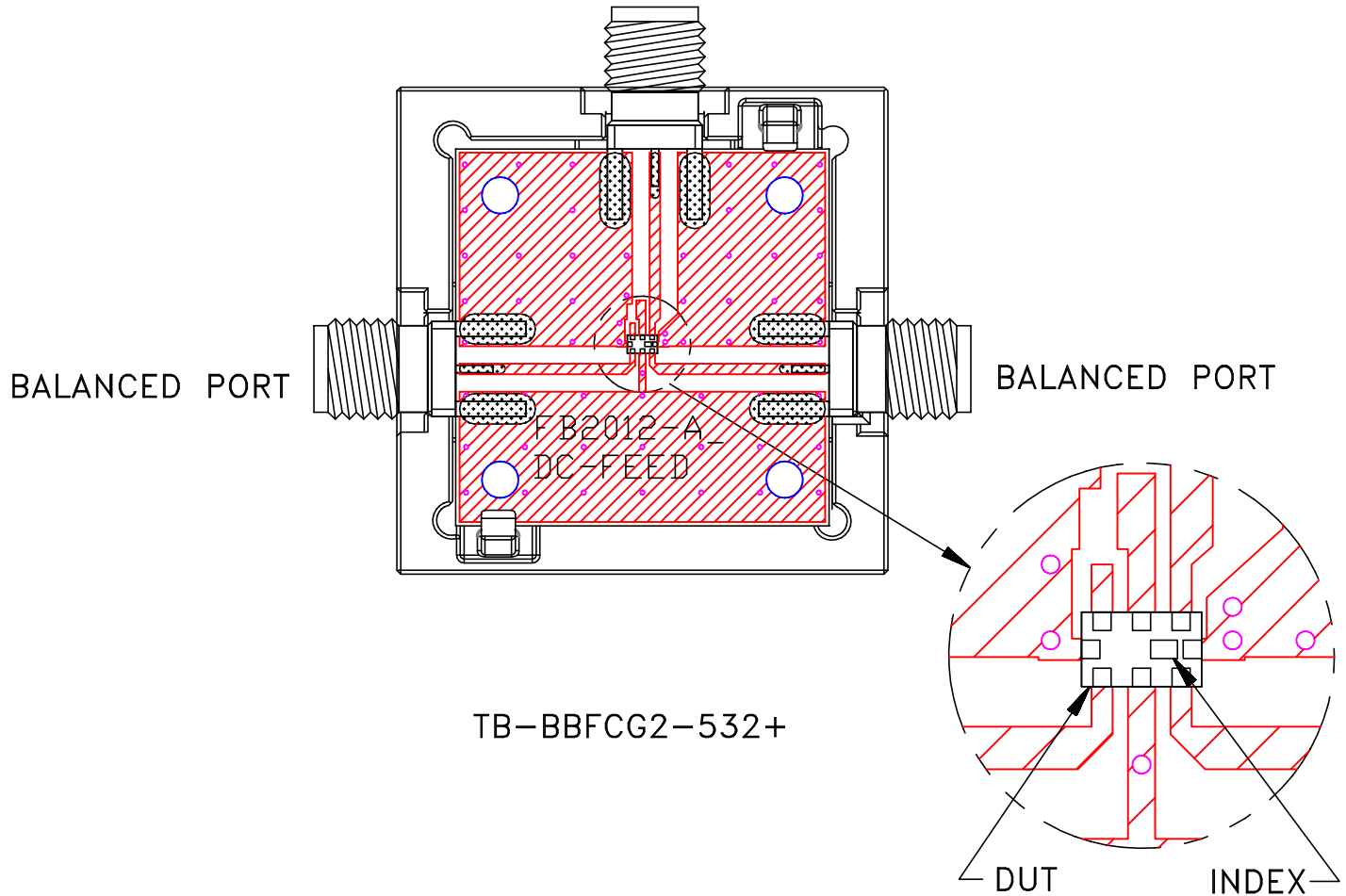
FILE: 98PL551	SCALE: 15:1	SHEET: 1 OF 1
------------------	----------------	------------------

Mini-Circuits®

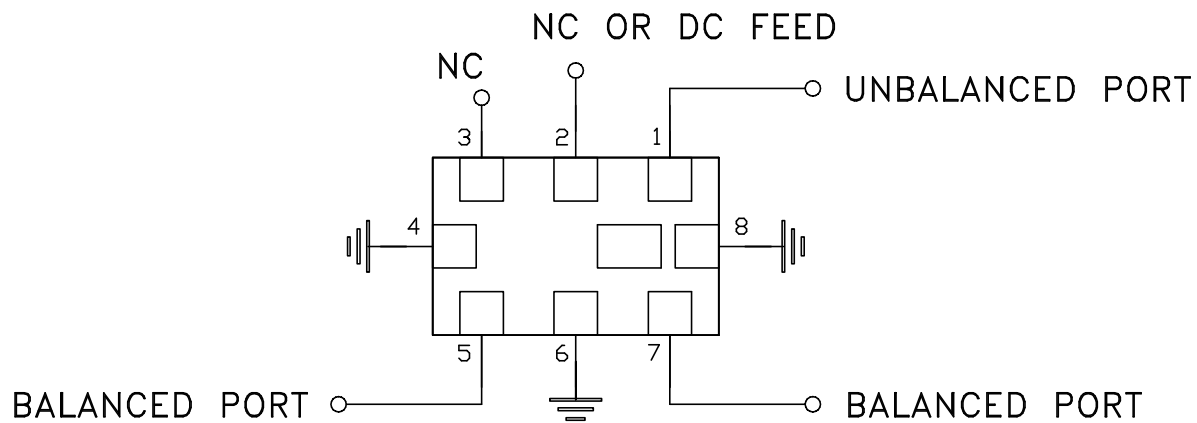
THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS. EXCEPT FOR USE EXPRESSLY GRANTED, IN WRITING, TO ITS VENDORS, VENDEE AND THE UNITED STATES GOVERNMENT, MINI-CIRCUITS RESERVES ALL PROPRIETARY DESIGN, USE, MANUFACTURING AND REPRODUCTION RIGHTS THERETO. THESE CONTENTS SHALL NOT BE USED, DUPLICATED OR DISCLOSED TO ANY OUTSIDE PARTY, IN WHOLE OR IN PART, WITHOUT WRITTEN PERMISSION OF MINI-CIRCUITS.

Evaluation Board and Circuit

UNBALANCED PORT




TB-BBFCG2-532+



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: FR4 or equivalent,
Dielectric Constant=4.5, Thickness=.016 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process: 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2; Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A